

## **Characterization of tunnel oxides in TOPCon solar cells**

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## **Tunnel Oxide Passivating Contact (TOPCon) Cells Results** Analysis of Material Internolation Fit **TOPCon Tunnel Oxide Optical and Structural Properties TOPCon Structure Boned on Motive Silicon Ovid**  $Al_2O_3/$ • Refractive index at 2 eV: • Interface between the boron doped  $p^*$  Si layer and the  $-4-MSF$ polysilicon *1.82* SiN<sub>v</sub> phosphorus doped c-Si wafer form a p/n junction where all • Thickness (nm): electron/hole pairs (EHPs) are separated by carrier type  $c-Si(n)$ *1.12* • Electrons gather at the back contacts and holes gather at the tunnel oxide  $MSE$ front contacts *1.5* • SiO<sub>2</sub> layer allows electrons to tunnel through; however, holes silicon wafer are blocked SiO<sub>2</sub> tunnel oxide  $SiO<sub>2</sub>$  Tunnel Oxide ~ 1.12 nm •  $AI<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>$  layers passivate the poly-Si layers and provide anti-reflection coating Биш Crystal Silicon Substrate  $1.4$   $1.5$   $1.6$   $1.7$ Index of Refraction at 2 eV *Figure 2 – TEM image of SiO2 and poly-Si interface. From Tao et al. 2024* **Figure 8 – Tunnel oxide sample structure** Best fit of both models *Figure 1 – TOPCon solar cell structure.*  tunnel oxide tunnel oxide *From Verlinden et al. 2023* produce the same thickness and index of refraction  $3.2eV$ high resistivity Tunnel Ovide Fit Results  $n^+$  polygilicon high resistivity silicon wafer  $n^+$  polysilicor **Tunnel Oxide Design Challenges** eilicon wafer Rased on Thermal Silicon Oxide **Tunnel Oxides** • Optical properties need to be well defined Two Main Functions: مممما  $\cdot$  The SiO<sub>2</sub>/c-Si interface can influence the  $H - MSE$ *1. Quantum Tunneling* – Enables carrier movement  $E_{\rm C}$  ees  $\mathbf{E}$ optical behavior of thin-film SiO<sub>2</sub> layers across interface. Can be designed to favor one type • Quantum tunneling probability is more of charge carrier over another via interaction with sensitive to the width of a potential barrier poly-Si [Fig. 3]. If barrier is too thick, tunneling stops than to the strength of the potential, so film *2. Passivation* – Prevents formation of material defects at thickness is the primary design parameter. 4.7 eV interface slowing the recombination rate of EHPs. If Choi *et al.* found in their work that the barrier is too thin, passivation is inadequate  $(a)$  $(b)$ optimal thickness is 1.2 – 1.5 nm *Figure 3 – Bandgap diagram detailing tunneling effect. From Tao et al. 2024* **Spectroscopic Ellipsometry**  $\overline{12}$  $\begin{array}{cccccccccccccc} 16 & 16 & 17 & 18 & 18 \\ \end{array}$ .<br>Energy (eV) Index of Refraction at 2 eV *Figure 9 – Plot of tunnel oxide Figure 10 – Analysis of tunnel oxide experimental and optical model data index of refraction* **Complex Reflection Ratio Optical Modelling Basics** • Light emitted from the lamp is linearly • Data analysis software is used to **Conclusion and Future Work** • Defines the ratio ( $\rho$ ) of the parallel ( $\tilde{r}_P$ ) and polarized and reflected off sample create models that match *Lamp and polarizer Rotating compensator,*  • The reflection changes the polarization perpendicular  $(\tilde{r}_S)$  components of light by the experimental data with the lowest *analyzer and detector* The 1.12 nm thickness for the tunnel oxide layer is near the optimal changes in amplitude and phase upon reflection to elliptical [Fig. 5] possible MSE. This yields data on: range described by Choi *et al*. This thickness should be effective at enabling 1. Material thickness • Changes in received waves are quantum tunneling; however, it is slightly lower than the reported optimal range  $\tilde{\rho} = \frac{r_p}{\tilde{r}_p} = tan\Psi * e^{i\Delta}$ analyzed to measure changes in 2. Index of refraction (n) which could negatively impact the passivation of the poly-Si interface. An amplitude and phase [Fig. 6]. This  $r_{\rm s}$ 3. Extinction coefficient (k) appropriate balance between the two functions must be met to optimize provides data for parameters Psi and efficiency. *Sample*  $\cos \theta_i - (N_i^2)$ Follow up work could focus on testing the optimal range for tunnel oxide Exp. Dat • *Psi(Ψ)* – Relates amplitude of emitted thickness in TOPCon solar cells, as well as improving the manufacturing Measurement vs. received waves process to produce better control of film thickness. • *Delta(Δ)* – Relates phase difference of •  $N_i = N_f/N_i$  where  $N_i$  and  $N_t$  are the complex indices This work could be extended into more advanced TOPCon solar cells of refraction for the incident and transmission media emitted vs received waves Gen. Dat including double or triple stack structures, as well as experimental pinhole •  $\theta_1$  – angle of incidence *Figure 4 – M2000 Ellipsometer* Model designs. **Figure of Merit Acknowledgments** • Analytical process to minimize the difference Compare { between the experimental data and optical model Fit  $\overline{\leftrightarrow}$ • This difference is measured by the Mean Squared **Fit Parameter** I would like to thank Dr. Jason Stoke for his constant guidance, his passion for teaching, and his Error (MSE): endless patience. I would also like to thank Dr. David Young, Dr. Paul Stradins and Bill Nemeth, all of whom provided invaluable mentorship during this experience. Finally, I would like to thank **Results** NREL and the DOE for the opportunity to take part in this program. choth index 2 2 2  $MSE = \frac{1}{2n}$  $n \t \frac{N_{E_i} - N_{G_i}}{N}$ +  $\frac{C_{E_i} - C_{G_i}}{0.001}$ +  $\frac{S_{E_i} - S_{G_i}}{0.001}$  $\frac{1}{3n-m}\sum_{i=1}$ **References** 0.001 0.001 0.001 *Figure 7 – Optical modelling flowchart* • *n* – number of experimental data • *G* – model value Reflect off Sample • Pierre Verlinden *et al*., "Photovoltaic device innovation for a solar future,"

*Figure 5 – Diagram detailing polarization change due to reflection*

Delta

Linearly Polarized Ligh



*amplitude change due to material thickness and index of refraction*

$$
\text{MSE} = \sqrt{\frac{1}{3n - m} \sum_{i=1}^{n} \left[ \frac{N_{E_i} - N_{G_i}}{0.001} \right)^2 + \left( \frac{C_{E_i} - C_{G_i}}{0.001} \right)^2 + \left( \frac{S_{E_i} - S_{G_i}}{0.001} \right)^2}
$$
\n
$$
\cdot \begin{array}{c}\n\text{ n-number of experimental data:} \\
\text{ points:} \\
\text{ n-number of free parameters:} \\
\text{ m node of free parameters:} \\
\text{ n complex:} \\
\text{ m node:} \\
\text{ m node:} \\
\text{ m-p-number of free parameters:} \\
\text{ s-sin(24P)\cdot\text{sin}(\Delta)} \\
\text{ s-sin(24P)\cdot\text{sin}(\Delta)}\n\end{array}
$$

*Figures 4-7 from J.A. Woollam Company*

*Optical modelling software CompleteEASE is used for all data analysis in this research. Provided by J.A. Woollam Company* • Yuguo Tao, Mackenzie Duce and Anna Erickson, "Tunnel oxide passivating

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